

## LM3045/LM3046/LM3086 Transistor Arrays

### General Description

The LM3045, LM3046 and LM3086 each consist of five general purpose silicon NPN transistors on a common monolithic substrate. Two of the transistors are internally connected to form a differentially-connected pair. The transistors are well suited to a wide variety of applications in low power system in the DC through VHF range. They may be used as discrete transistors in conventional circuits however, in addition, they provide the very significant inherent integrated circuit advantages of close electrical and thermal matching. The LM3045 is supplied in a 14-lead cavity dual-in-line package rated for operation over the full military temperature range. The LM3046 and LM3086 are electrically identical to the LM3045 but are supplied in a 14-lead molded dual-in-line package for applications requiring only a limited temperature range.

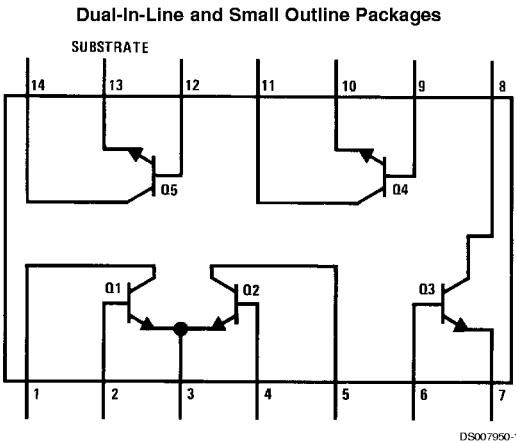
### Features

- Two matched pairs of transistors  
 $V_{BE}$  matched  $\pm 5$  mV  
 Input offset current 2  $\mu$ A max at  $I_C = 1$  mA
- Five general purpose monolithic transistors
- Operation from DC to 120 MHz
- Wide operating current range
- Low noise figure: 3.2 dB typ at 1 kHz
- Full military temperature range (LM3045): -55°C to +125°C

### Applications

- General use in all types of signal processing systems operating anywhere in the frequency range from DC to VHF
- Custom designed differential amplifiers
- Temperature compensated amplifiers

### Schematic and Connection Diagram



**Top View**  
**Order Number LM3045J, LM3046M, LM3046N or LM3086N**  
**See NS Package Number J14A, M14A or N14A**



## Electrical Characteristics (Continued)

( $T_A = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Conditions	Limits			Limits			Units	
		LM3045, LM3046			LM3086				
		Min	Typ	Max	Min	Typ	Max		
Collector to Emitter Saturation Voltage ( $V_{CE(SAT)}$ )	$I_B = 1 \text{ mA}, I_C = 10 \text{ mA}$		0.23			0.23		V	
Temperature Coefficient of Input Offset Voltage $\left(\frac{\Delta V_{IO}}{\Delta T}\right)$	$V_{CE} = 3V, I_C = 1 \text{ mA}$		1.1					$\mu\text{V}/^\circ\text{C}$	

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits.

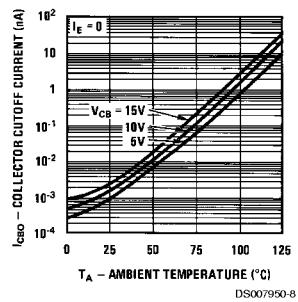
Note 2: The collector of each transistor of the LM3045, LM3046, and LM3086 is isolated from the substrate by an integral diode. The substrate (terminal 13) must be connected to the most negative point in the external circuit to maintain isolation between transistors and to provide for normal transistor action.

## Electrical Characteristics

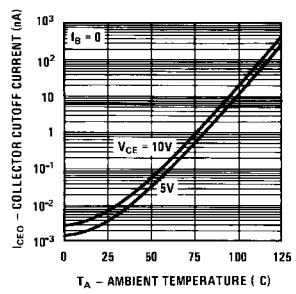
Parameter	Conditions	Min	Typ	Max	Units
Low Frequency Noise Figure (NF)	$f = 1 \text{ kHz}, V_{CE} = 3V, I_C = 100 \mu\text{A}, R_S = 1 \text{ k}\Omega$		3.25		dB
<b>LOW FREQUENCY, SMALL SIGNAL EQUIVALENT CIRCUIT CHARACTERISTICS</b>					
Forward Current Transfer Ratio ( $h_{fe}$ )	$f = 1 \text{ kHz}, V_{CE} = 3V, I_C = 1 \text{ mA}$		110 (LM3045, LM3046) (LM3086)		
Short Circuit Input Impedance ( $h_{ie}$ )			3.5		$\text{k}\Omega$
Open Circuit Output Impedance ( $h_{oe}$ )			15.6		$\mu\text{mho}$
Open Circuit Reverse Voltage Transfer Ratio ( $h_{re}$ )			$1.8 \times 10^{-4}$		
<b>ADMITTANCE CHARACTERISTICS</b>					
Forward Transfer Admittance ( $Y_{fe}$ )	$f = 1 \text{ MHz}, V_{CE} = 3V, I_C = 1 \text{ mA}$		$31 - j 1.5$		
Input Admittance ( $Y_{ie}$ )			$0.3 + j 0.04$		
Output Admittance ( $Y_{oe}$ )			$0.001 + j 0.03$		
Reverse Transfer Admittance ( $Y_{re}$ )			See Curve		
Gain Bandwidth Product ( $f_T$ )	$V_{CE} = 3V, I_C = 3 \text{ mA}$	300	550		
Emitter to Base Capacitance ( $C_{EB}$ )	$V_{EB} = 3V, I_E = 0$		0.6		$\text{pF}$
Collector to Base Capacitance ( $C_{CB}$ )	$V_{CB} = 3V, I_C = 0$		0.58		$\text{pF}$
Collector to Substrate Capacitance ( $C_{CS}$ )	$V_{CS} = 3V, I_C = 0$		2.8		$\text{pF}$

## Typical Performance Characteristics

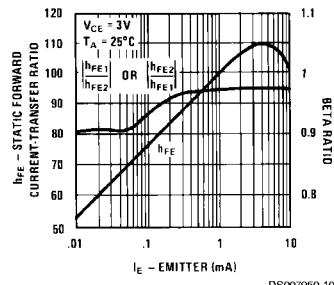
**Typical Collector To Base Cutoff Current vs Ambient Temperature for Each Transistor**



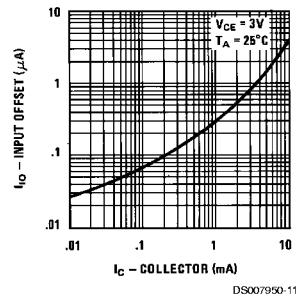
**Typical Collector To Emitter Cutoff Current vs Ambient Temperature for Each Transistor**



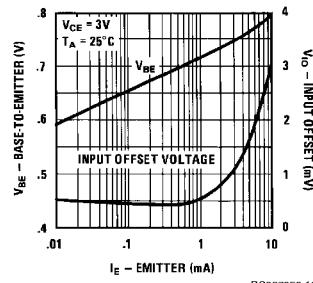
**Typical Static Forward Current-Transfer Ratio and Beta Ratio for Transistors Q<sub>1</sub> and Q<sub>2</sub> vs Emitter Current**



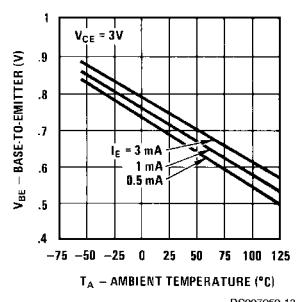
**Typical Input Offset Current for Matched Transistor Pair Q<sub>1</sub> Q<sub>2</sub> vs Collector Current**



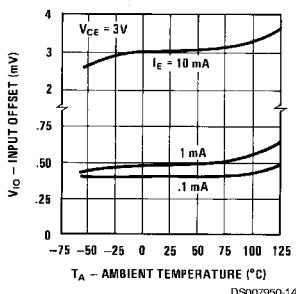
**Typical Static Base To Emitter Voltage Characteristic and Input Offset Voltage for Differential Pair and Paired Isolated Transistors vs Emitter Current**



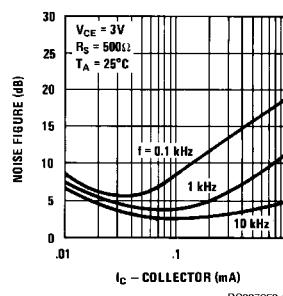
**Typical Base To Emitter Voltage Characteristic for Each Transistor vs Ambient Temperature**



**Typical Input Offset Voltage Characteristics for Differential Pair and Paired Isolated Transistors vs Ambient Temperature**

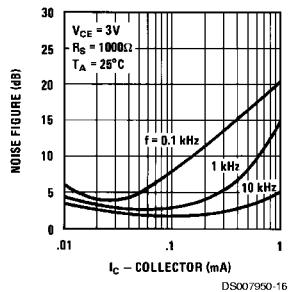


**Typical Noise Figure vs Collector Current**

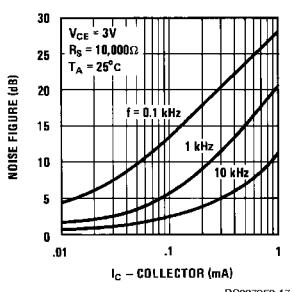


## Typical Performance Characteristics (Continued)

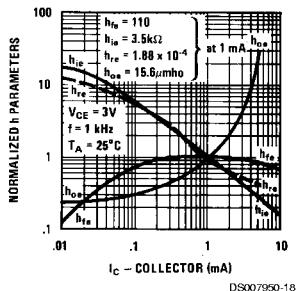
Typical Noise Figure vs  
Collector Current



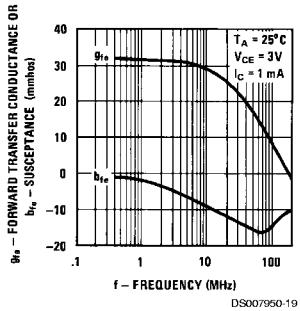
Typical Noise Figure vs  
Collector Current



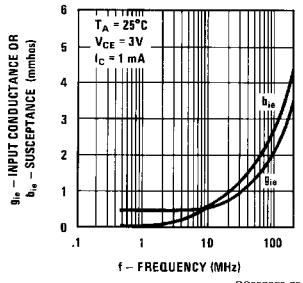
Typical Normalized Forward  
Current Transfer Ratio, Short  
Circuit Input Impedance,  
Open Circuit Output Impedance,  
and Open Circuit Reverse  
Voltage Transfer Ratio vs  
Collector Current



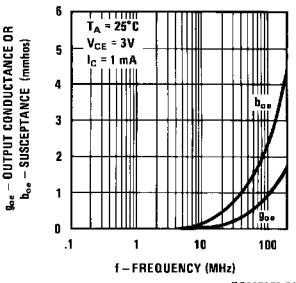
Typical Forward Transfer  
Admittance vs Frequency



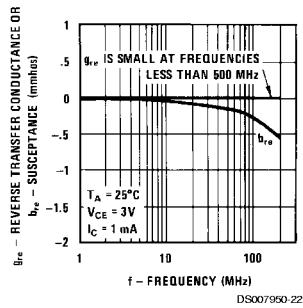
Typical Input Admittance  
vs Frequency



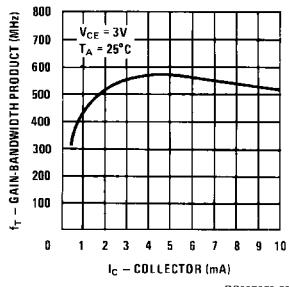
Typical Output Admittance  
vs Frequency



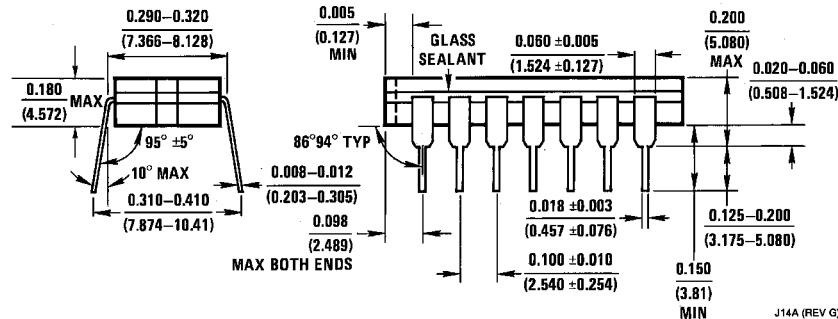
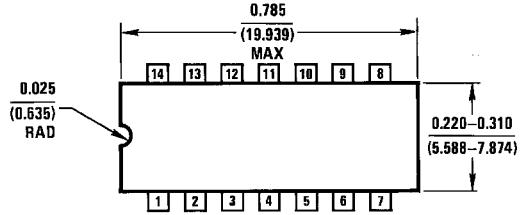
Typical Reverse Transfer  
Admittance vs Frequency



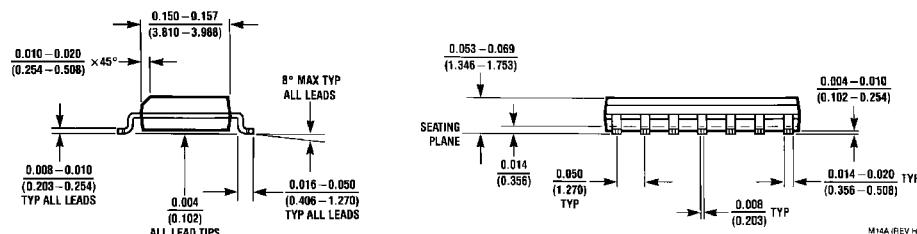
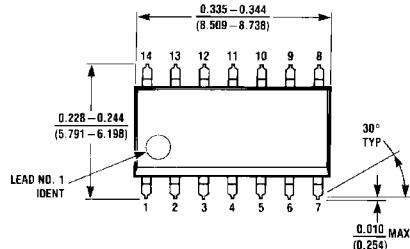
Typical Gain-Bandwidth  
Product vs Collector Current



**Physical Dimensions** inches (millimeters) unless otherwise noted



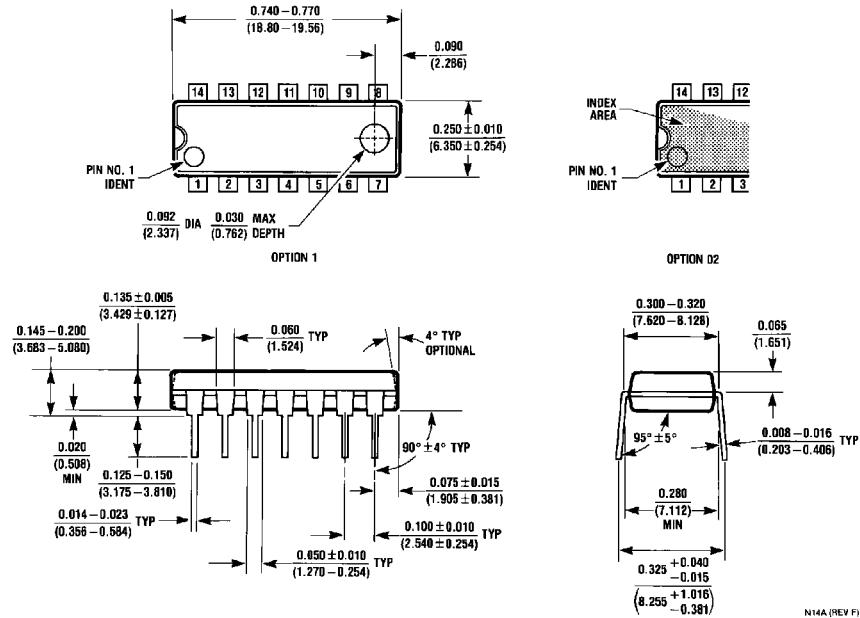
Ceramic Dual-In-Line Package (J)  
Order Number LM3045J  
NS Package Number J14A



Molded Small Outline Package (M)  
Order Number LM3046M  
NS Package Number M14A

## LM3045/LM3046/LM3086 Transistor Arrays

### Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



**Molded Dual-In-Line Package (N)**  
**Order Number LM3046N or LM3086N**  
**NS Package Number N14A**

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